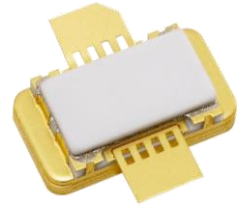


## ■ Features

- High Power GaN HEMT for DC to 3GHz
- High Power : 130W @ 2.45GHz
- High Efficiency: 59% @ 2.45GHz
- CW Operable
- Easy of Matching: Input Pre-matched for 3GHz
- Small Flangeless Package



## ■ Description

Sumitomo Electric's GaN-HEMT SGNH130M1H offers high power, high efficiency, ease of matching and greater consistency for DC to 3GHz high power applications with 50V operation.

### ABSOLUTE MAXIMUM RATING

Item	Symbol	Rating	Unit
Operating Voltage	$V_{DS}$	55	V
Drain-Source Voltage	$V_{DS}$	200 @ $V_{GS}=-8V$	V
Gate-Source Voltage	$V_{GS}$	-15	V
Total Power Dissipation	$P_t$	170 @ $T_c=25deg.C$	W
Storage Temperature	$T_{stg}$	-55 to +125	deg.C
Channel Temperature	$T_{ch}$	+250	deg.C

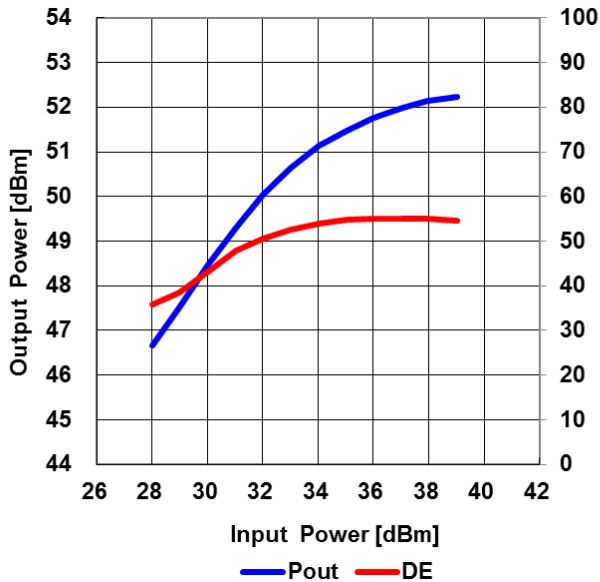
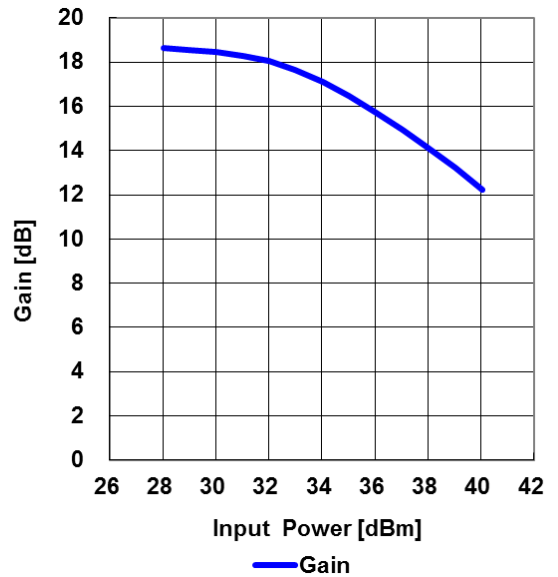
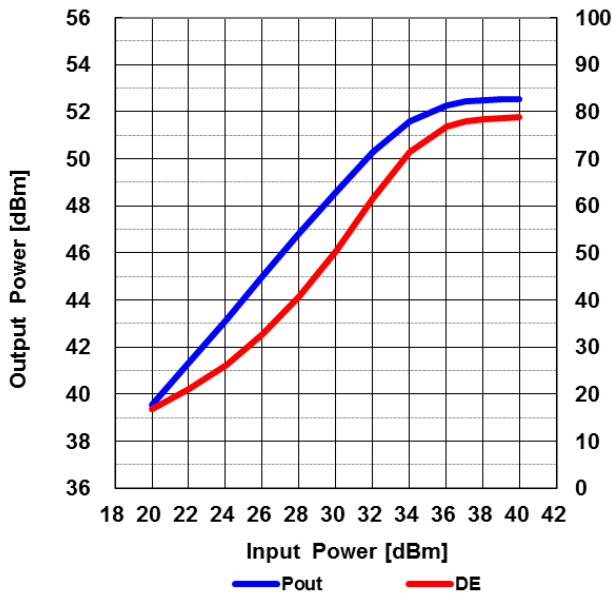
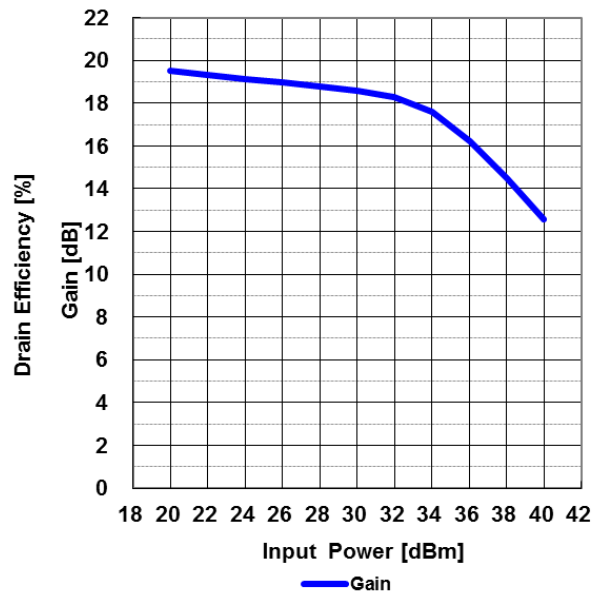
### RECOMMENDED OPERATING CONDITION(Case Temperature $T_c=25$ deg.C)

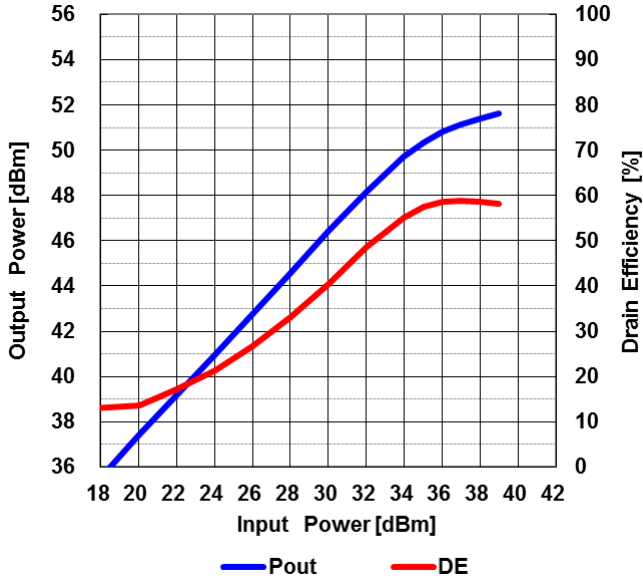
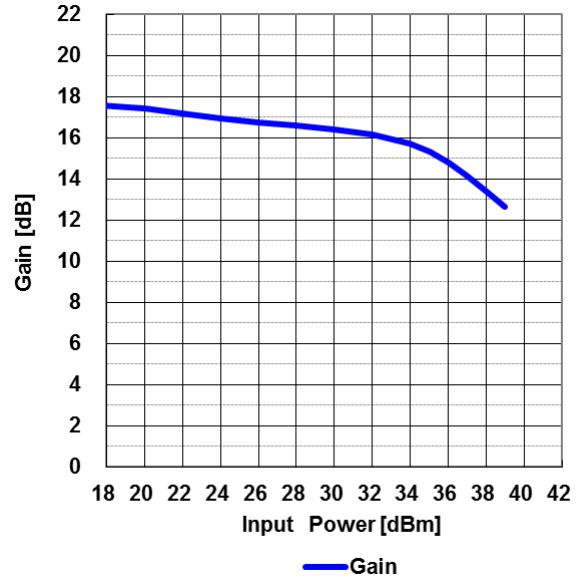
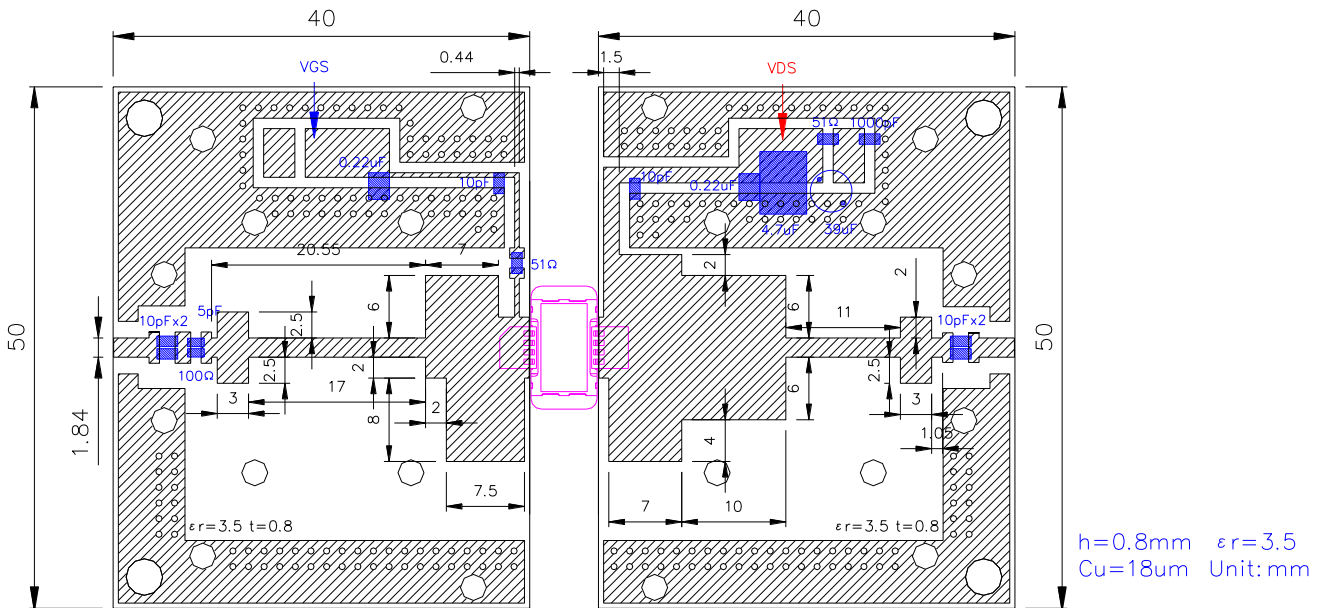
Item	Symbol	Condition	Limit	Unit
Drain-Source Voltage	$V_{DS}$		$\leq 50$	V
Forward Gate Current	$I_{GF}$	$R_g=50\Omega$	$\leq 125$	mA
Reverse Gate Current	$I_{GR}$	$R_g=50\Omega$	$\geq -7.2$	mA
Channel Temperature	$T_{ch}$		$\leq 180$	deg.C

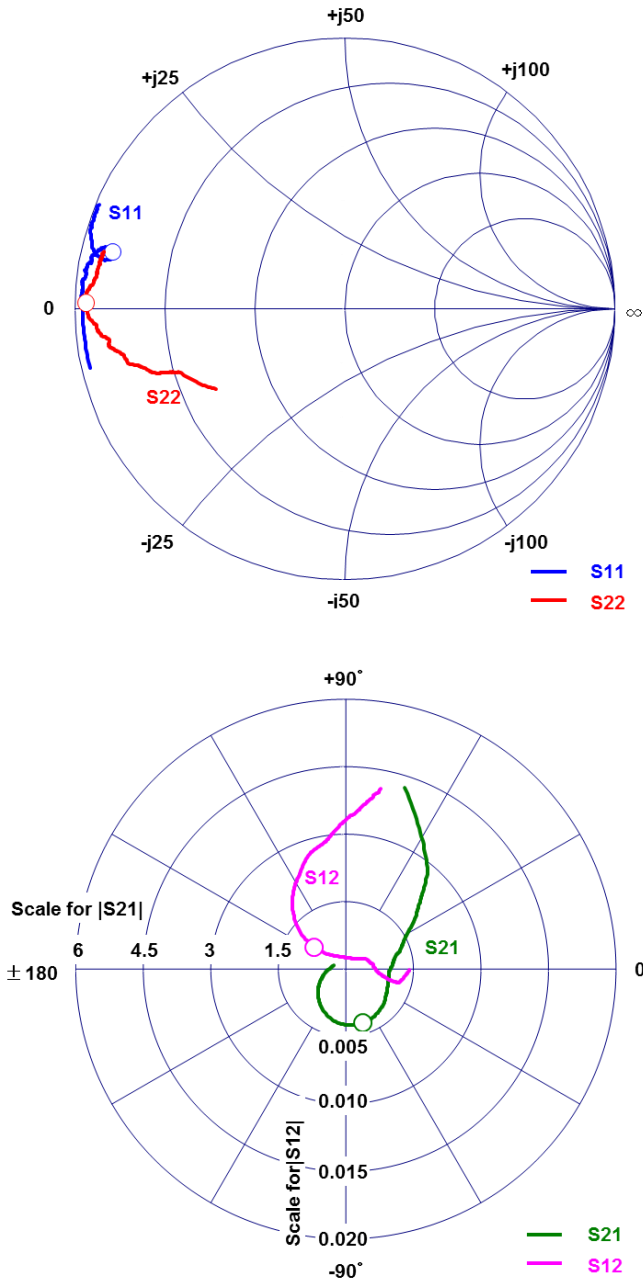
### ELECTRICAL CHARACTERISTICS (Case Temperature $T_c=25$ deg.C)

Item	Symbol	Condition	Limit			Unit
			Min.	Typ.	Max.	
Pinch-off Voltage	$V_p$	$V_{DS}=50V, I_{DS}=36mA$	-4.0	-2.5	-1.5	V
Saturated Power	$P_{sat}$	$V_{DS}=50V, I_{DS(DC)}=500mA,$ $P_{in}=38dBm, f=2.45GHz,$ CW	-	51.1	-	dBm
Drain Efficiency	DE		-	59.0	-	%
Power Gain	$G_p$		-	13.1	-	dB
Saturated Power	$P_{sat}$	$V_{DS}=50V, I_{DS(DC)}=500mA,$ $P_{in}=38dBm, f=3GHz,$ $PW=200\mu s, Duty=10\%$	51.1	51.9	-	dBm
Drain Efficiency	DE		50.0	56.5	-	%
Power Gain	$G_p$		-	13.9	-	dB
Thermal Resistance	$R_{th}$	Channel to Case at 90W $P_{DC}$	-	1.1	1.32	deg.C/W

Case Style	M1H
RoHS Compliance	YES

**RF Characteristics @f=3GHz, Pulse**
**Output Power and Drain Efficiency vs. Input Power**  
 VDS=50V, IDS (DC)=0.5A, f=3GHz,  
 Pulse Width=200μs, 10%-duty

**Gain vs. Input Power**  
 VDS=50V, IDS (DC)=0.5A, f=3GHz,  
 Pulse Width=200μs, 10%-duty

**RF Characteristics @f=500MHz, CW**
**Output Power and Drain Efficiency vs. Input Power**  
 VDS=50V, IDS (DC)=0.5A, f=500MHz, CW

**Gain vs. Input Power**  
 VDS=50V, IDS (DC)=0.5A, f=500MHz, CW


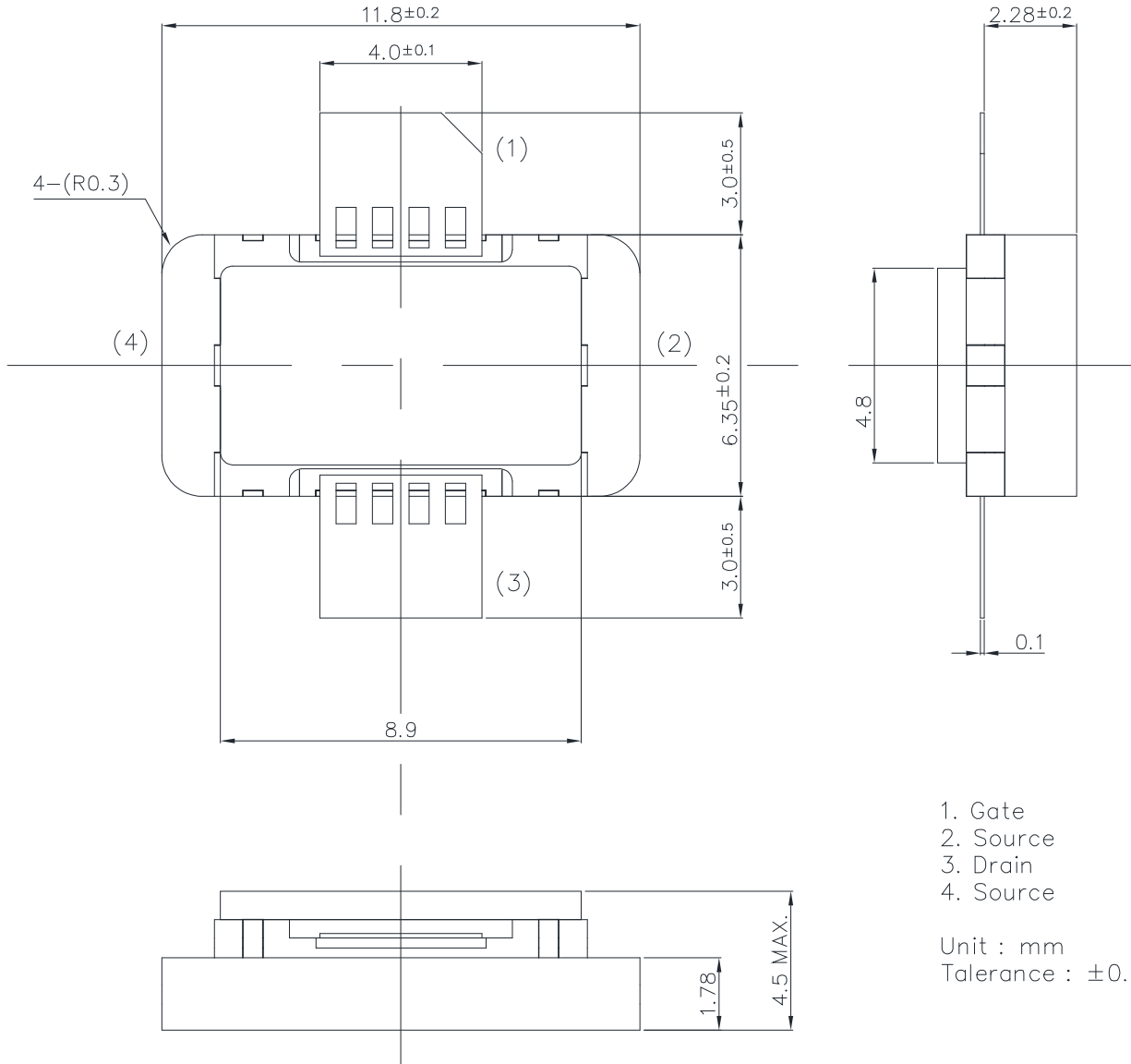
**RF Characteristics @f=2.45GHz, CW**
**Output Power and Drain Efficiency vs. Frequency**  
 VDS=50V, IDS (DC)=0.5A, f=2.45GHz, CW

**Gain vs. Input Power**  
 VDS=50V, IDS (DC)=0.5A, f=2.45GHz, CW

**Test Fixture for 2.45GHz**


**S-parameters**
 $V_{DS}=50V$ ,  $I_{DS(DC)}=0.5A$ ,  $f=0.5$  to  $4.5GHz$ ,  $Z_l=Z_s=50\text{ ohm}$ , Marker:  $3.0GHz$ 


Freq. GHz	S11		S21		S12		S22	
	MAG	ANG	MAG	ANG	MAG	ANG	MAG	ANG
0.5	0.97	-167.05	4.24	71.99	0.005	-0.66	0.56	-148.35
0.6	0.97	-173.95	3.39	60.26	0.004	-8.18	0.61	-153.37
0.7	0.97	179.51	2.78	49.11	0.004	-14.65	0.65	-158.82
0.8	0.97	178.64	2.36	44.28	0.004	-14.75	0.68	-160.00
0.9	0.97	177.81	2.08	39.76	0.003	-14.21	0.71	-160.62
1.0	0.98	177.21	1.86	35.31	0.003	-13.80	0.74	-161.10
1.1	0.98	176.59	1.65	31.40	0.003	-12.46	0.76	-162.41
1.2	0.97	175.87	1.48	27.56	0.003	-10.67	0.78	-163.90
1.3	0.98	174.88	1.37	23.21	0.003	-8.90	0.80	-164.82
1.4	0.98	174.45	1.28	19.46	0.002	-6.10	0.82	-165.52
1.5	0.98	173.95	1.18	16.16	0.002	-1.93	0.83	-166.83
1.6	0.97	173.28	1.11	12.20	0.002	3.32	0.84	-168.32
1.7	0.97	172.23	1.06	8.41	0.002	7.56	0.85	-169.27
1.8	0.98	171.68	1.04	4.59	0.002	11.16	0.87	-169.92
1.9	0.97	171.23	1.00	0.93	0.002	15.01	0.88	-170.74
2.0	0.97	170.42	0.97	-2.56	0.002	20.40	0.88	-171.72
2.1	0.96	169.96	0.96	-7.02	0.002	23.74	0.89	-172.90
2.2	0.95	168.98	0.97	-11.59	0.002	27.00	0.90	-173.45
2.3	0.96	168.37	0.97	-16.22	0.002	30.41	0.91	-174.36
2.4	0.95	167.93	1.00	-20.33	0.001	36.02	0.92	-175.24
2.5	0.94	167.04	1.03	-26.21	0.001	44.01	0.92	-175.84
2.6	0.93	166.52	1.07	-32.93	0.001	61.81	0.93	-176.77
2.7	0.92	165.95	1.13	-40.30	0.001	92.68	0.95	-177.83
2.8	0.91	165.50	1.18	-49.63	0.001	123.39	0.95	-178.96
2.9	0.89	165.75	1.23	-60.45	0.002	141.60	0.95	-179.94
3.0	0.89	166.27	1.25	-72.72	0.003	145.16	0.96	-178.70
3.1	0.88	167.22	1.25	-86.40	0.004	141.90	0.96	-177.16
3.2	0.89	167.96	1.19	-101.06	0.006	134.24	0.95	-175.90
3.3	0.90	168.49	1.09	-114.81	0.007	125.90	0.95	-175.08
3.4	0.92	168.28	0.96	-127.19	0.008	118.25	0.94	-174.57
3.5	0.95	167.83	0.84	-137.44	0.008	111.98	0.94	-173.75
3.6	0.96	166.77	0.73	-146.27	0.009	106.09	0.93	-172.98
3.7	0.96	165.82	0.63	-154.20	0.009	100.76	0.93	-172.66
3.8	0.97	164.67	0.56	-160.79	0.010	97.10	0.93	-171.98
3.9	0.98	163.40	0.50	-166.67	0.010	94.15	0.93	-171.31
4.0	0.99	162.28	0.44	-172.06	0.011	91.24	0.92	-170.54
4.1	0.99	161.45	0.40	-176.87	0.011	88.55	0.92	-169.99
4.2	0.99	160.28	0.36	-178.49	0.012	86.14	0.92	-169.44
4.3	0.99	158.93	0.33	-173.40	0.012	83.55	0.92	-168.32
4.4	0.99	158.01	0.30	-168.72	0.013	81.18	0.92	-167.54
4.5	0.99	157.10	0.28	-164.35	0.014	78.95	0.92	-166.72

■ Package Outline

**Case Style: M1H**



- 1. Gate
- 2. Source
- 3. Drain
- 4. Source

Unit : mm  
Tolerance :  $\pm 0.15$

## **For Safety, Observe the Following Procedures Environmental Management**

- Do not put this product into the mouth.
- Do not alter the form of this product into a gas, powder, or liquid through burning, crushing, or chemical processing as these by-products are dangerous to the human body if inhaled, ingested, or swallowed.
- Respect all applicable laws of the country when discarding this product.  
This product must be disposed in accordance with methods specified by applicable hazardous waste procedures.

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